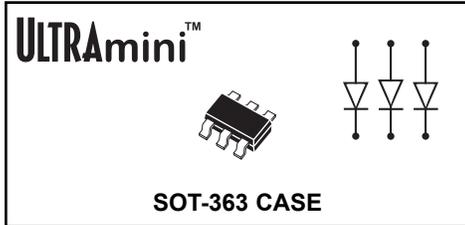


**CMKSH2-4LR**  
**SURFACE MOUNT**  
**ULTRAmi™**  
**TRIPLE ISOLATED**  
**SILICON LOW  $V_F$  SCHOTTKY DIODES**



# Central™

**Semiconductor Corp.**

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMKSH2-4LR type contains three (3) Isolated Silicon Low  $V_F$  Schottky Diodes, epoxy molded in a SOT-363 surface mount package. This ULTRAmi™ device has been designed for switching applications requiring a low forward voltage drop.

**MARKING CODE: CHTL**

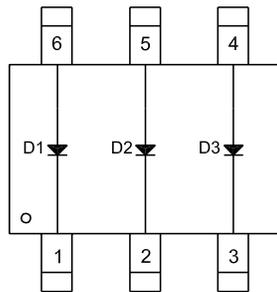
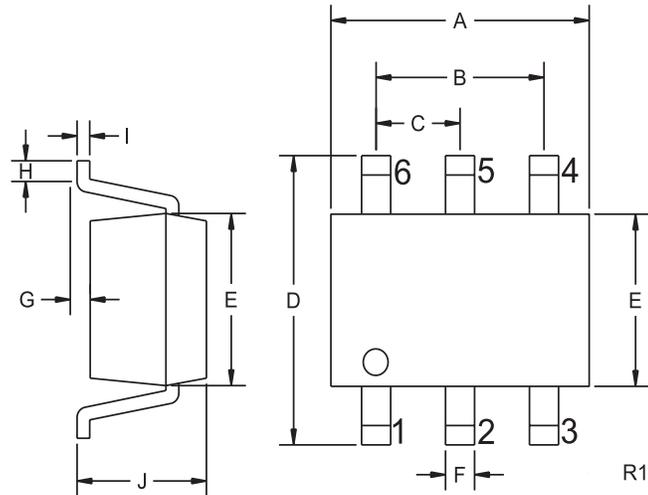
**MAXIMUM RATINGS:** ( $T_A=25^\circ\text{C}$ )

	<b>SYMBOL</b>		<b>UNITS</b>
Peak Repetitive Reverse Voltage	$V_{RRM}$	40	V
Continuous Forward Current	$I_F$	200	mA
Peak Repetitive Forward Current	$I_{FRM}$	350	mA
Forward Surge Current, $t_p=10\text{ms}$	$I_{FSM}$	1.0	A
Power Dissipation	$P_D$	350	mW
Operating and Storage			
Junction Temperature	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$
Thermal Resistance	$\theta_{JA}$	357	$^\circ\text{C/W}$

**ELECTRICAL CHARACTERISTICS PER DIODE:** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

<b>SYMBOL</b>	<b>TEST CONDITIONS</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNITS</b>
$I_R$	$V_R=20\text{V}$		11	50	$\mu\text{A}$
$BV_R$	$I_R=100\mu\text{A}$	40	53		V
$V_F$	$I_F=10\text{mA}$		0.24	0.325	V
$V_F$	$I_F=100\text{mA}$		0.35	0.4	V
$V_F$	$I_F=200\text{mA}$		0.42	0.5	V
$C_T$	$V_R=4.0\text{V}, f=1.0\text{ MHz}$		8.5	10	pF
$t_{rr}$	$I_F=I_R=10\text{mA}, I_{rr}=1.0\text{mA}, R_L=100\Omega$		4.0	5.0	ns

SOT-363 CASE - MECHANICAL OUTLINE



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.073	0.085	1.85	2.15
B	0.051		1.30	
C	0.026		0.65	
D	0.075	0.091	1.90	2.30
E	0.043	0.055	1.10	1.40
F	0.006	0.012	0.15	0.30
G	0.000	0.004	0.00	0.10
H	0.010	-	0.25	-
I	0.004	0.010	0.10	0.25
J	0.031	0.039	0.80	1.00

SOT-363 (REV: R1)

**LEAD CODE:**

- 1) CATHODE D1
- 2) CATHODE D2
- 3) CATHODE D3
- 4) ANODE D3
- 5) ANODE D2
- 6) ANODE D1

**MARKING CODE: CHTL**